

Switching diode

- **Applications**

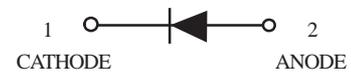
High speed switching

- **Features**

- 1) Extremely small surface mounting type.
- 2) High Speed. ($t_{rr} = 1.2\text{ns Typ.}$)
- 3) High reliability.

- **Construction**

Silicon epitaxial planar



- **Device Marking and Ordering Information**

Device	Marking	Shipping
FDS160ET1G	A	3000/Tape&Reel

ABSOLUTE MAXIMUM RATINGS ($T_a = 25\text{ }^\circ\text{C}$)

Parameter	Symbol	Limit	Unit
Peak reverse voltage	V_{RM}	90	V
DC reverse voltage	V_R	80	V
Peak forward current	I_{FM}	225	mA
Mean rectifying current	I_O	100	mA
Surge current (1s)	I_{surge}	500	mA
Power Dissipation (Note1) $T_a=25\text{ }^\circ\text{C}$	P_D	150	mW
Junction temperature	T_j	125	C
Storage temperature	T_{sg}	- 55 ~ +125	C

Note1: FR-5 Mimum PAD.

ELECTRICAL CHARACTERISTICS ($T_a = 25\text{ }^\circ\text{C}$)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Forward voltage	V_F	-	-	1.2	V	$I_F=100\text{mA}$
Reverse current	I_R	-	-	0.1	μA	$V_R=80\text{V}$
Capacitance between terminals	C_T	-	0.72	3.0	pF	$V_R=0.5\text{V}$, $f=1\text{MHz}$
Reverse recovery time	t_{rr}	-	-	4	ns	$V_R=6\text{V}$, $I_F=10\text{mA}$, $R_L=100\Omega$

ELECTRICAL CHARACTERISTIC CURVES

($T_a = 25^\circ\text{C}$)

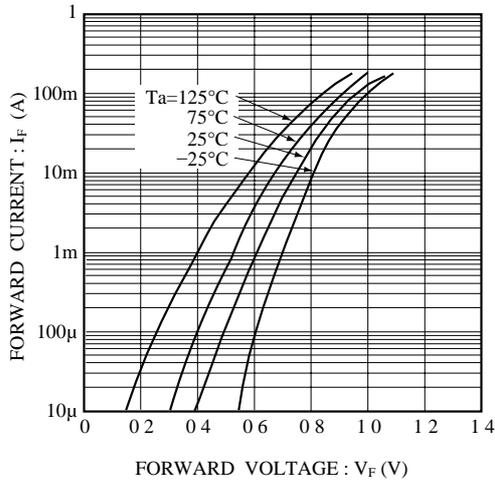


Fig.1 Forward characteristics

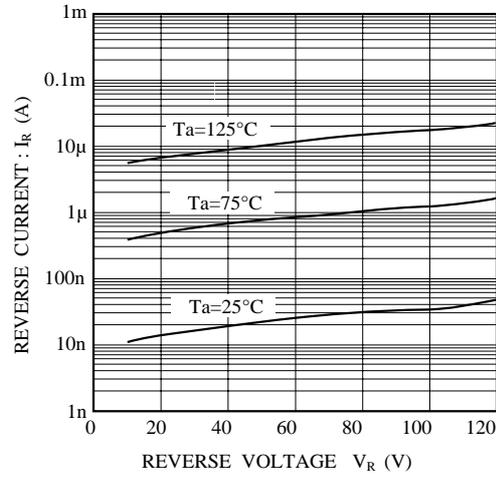


Fig.2 Reverse characteristics

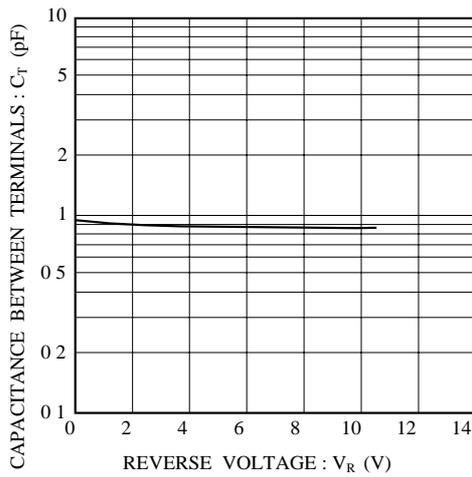


Fig.3 Capacitance between terminals characteristics

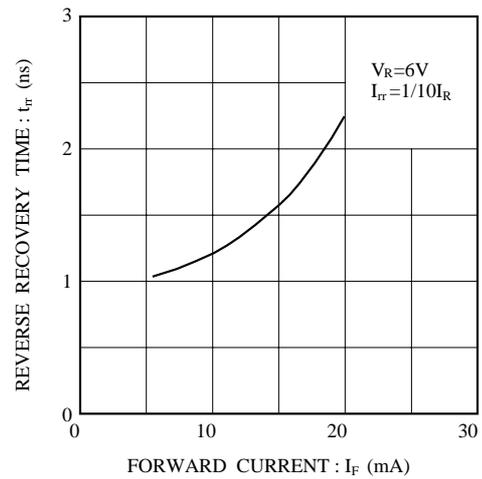


Fig.4 Reverse recovery time characteristics

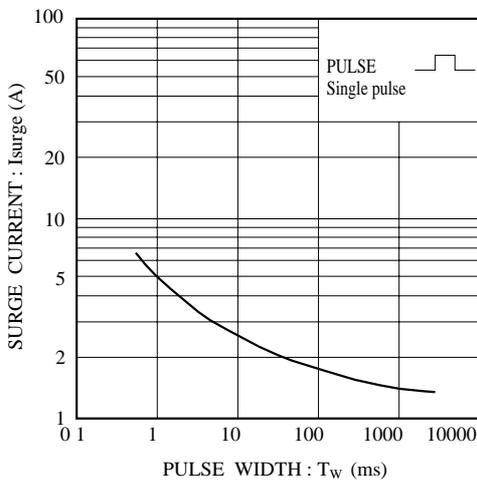


Fig.5 Surge current characteristics

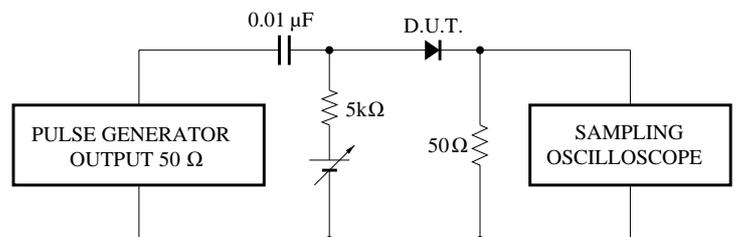
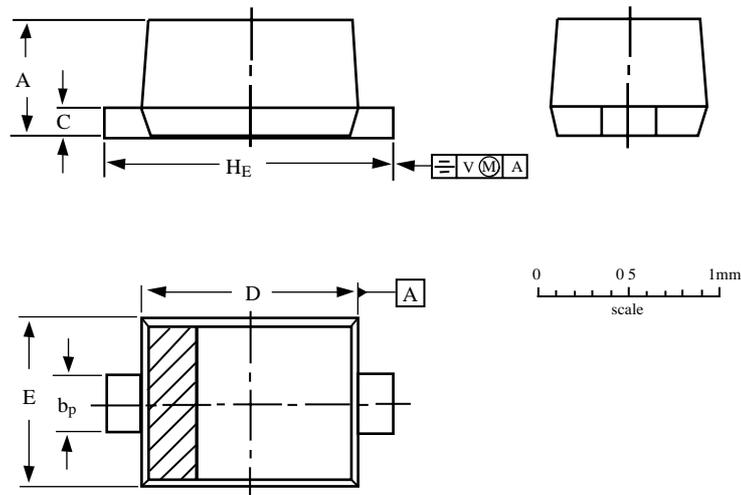


Fig.6 Reverse recovery time (t_{rr}) measurement circuit

SC-79 / SOD-523



0.7	0.35	0.2	1.3	0.9
0.5	0.25	0.1	1.1	0.7

DIMENSIONS (mm are the original dimensions)

UNIT	A	b _p	c	D	E	H _E	V
mm	0.7	0.35	0.2	1.3	0.9	1.7	0.15
	0.5	0.25	0.1	1.1	0.7	1.5	

Note

- The marking bar indicates the cathode.

OUTLINE VERSION	REFERENCES			EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ		
SOD523			SC-79		98-11-25